

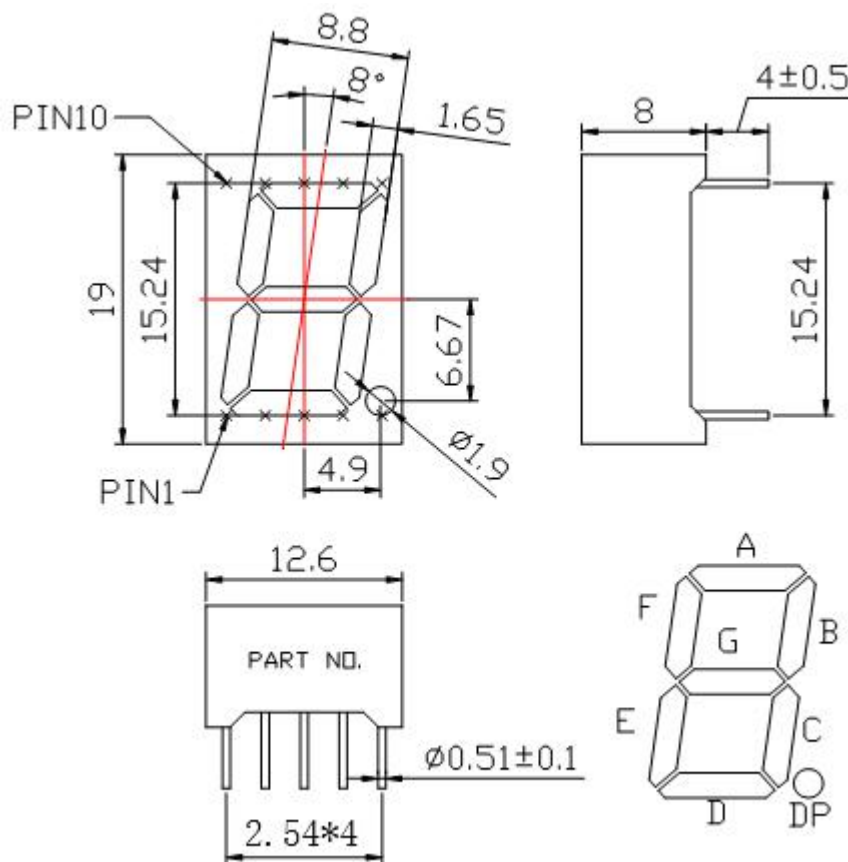
WCN1-0260DG-A21

SPECIFICATION

WCN			CUSTOMER Confirmed
Prepared by	Checked by	Approved by	
Zhang 2021-6-5	Athena	William	
REVISION RECORD			

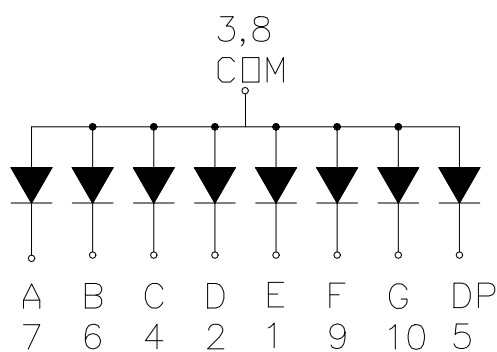
**REVISION: A0**

■ **Outer Dimension:**



Notes: Unless otherwise stated, the tolerance is $\pm 0.25\text{mm}$.

■ **Circuit Diagram:**



■ Pin Connection:

PIN NO.	CONNECTION	PIN NO.	CONNECTION
1	Cathode E	6	Cathode B
2	Cathode D	7	Cathode A
3	Common Anode	8	Common Anode
4	Cathode C	9	Cathode F
5	Cathode DP	10	Cathode G

■ Features:

- High Reliability
- Color: Bright Yellow Green
- Low Power Requirement
- Easy Assembly

■ Description:

- Single Digit LED Display
- Digit Height: 15.24mm(0.6")
- Black Face and Green Segment

■ Absolute Maximum Rating (Ta=25°C):

Parameter	Symbol	Condition	Color	Rating	Units
Power Dissipation Per LED	P _d	—	Yellow Green	65	mW
Forward Current Per LED	I _F	—	Yellow Green	25	mA
Peak Forward Current Per LED	I _{FP}	1/10 Duty 10KHz	Yellow Green	100	mA
Reverse Voltage Per LED	V _R	—	Yellow Green	5	V
Operating Temperature Range	Topr	—	—	-35~+85	°C
Storage Temperature Range	Tstg	—	—	-35~+85	°C

■ Electrical/Optical Characteristics Rating(Ta=25°C)

Item	Symbol	Test conditions	Location	Rating			Units
				Min.	Typ.	Max.	
Forward Voltage	V _F	I _F =20mA	Per LED	—	2.10	2.60	V
Reverse Current	I _R	V _R =5V	Per LED	—	—	100	μA
Luminous Intensity	I _V	I _F =10mA	Per LED	7201	—	12800	ucd
Peak Emission Wave Length	λ _P	I _F =20mA	Per LED	—	568	—	nm
	λ _D				570		
Spectral Line Half Width	Δλ	I _F =20mA	Per LED	—	20	—	nm

■ Luminous Intensity Sorting: (Luminous Intensity Tolerance is +/-10%)

Rank	Symbol	Condition	Min	Max	Unit
N	N	I _F =10mA	7201	8500	ucd
O	O	I _F =10mA	8501	10500	ucd
P	P	I _F =10mA	10501	12800	ucd

■ Hue Grade: I_F=20mA (Hue:+/-1nm)

Rank	Symbol	Hue Range	Units
C3	C3	567.5~570.0	nm
C4	C4	570.1~572.5	nm

■ Soldering Conditions: Soldering Temp. ≤+260°C, Soldering Time. ≤3sec. (at 2mm Distance from The Case of Reflector Edge)

■ **Typical Elector-Optical Characteristics Curve:**

Fig 1. Forward Current vs. Forward Voltage

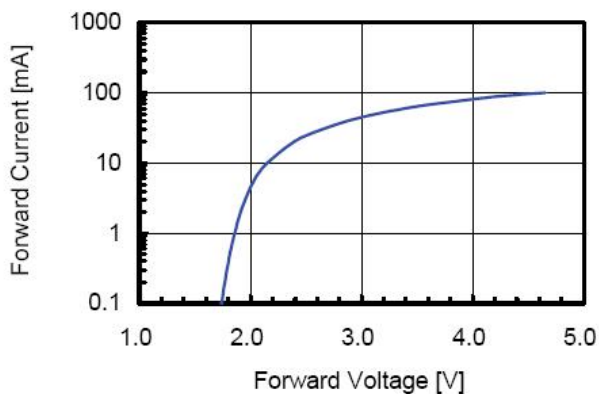


Fig 2. Relative Intensity vs. Forward Current

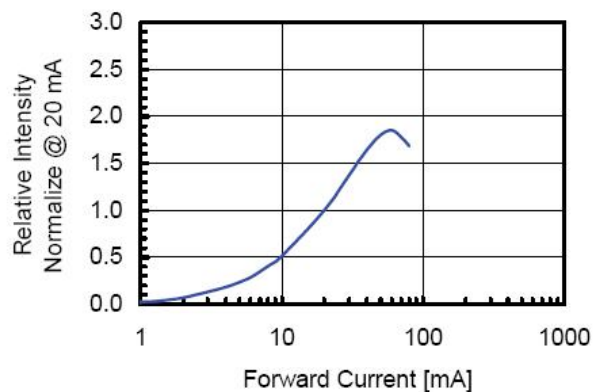


Fig 3. Forward Voltage vs. Temperature

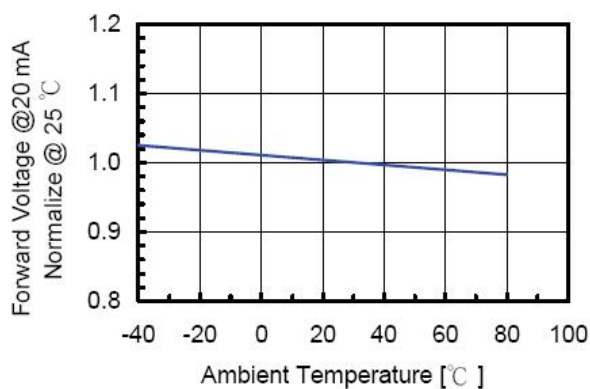


Fig 4. Relative Intensity vs. Temperature

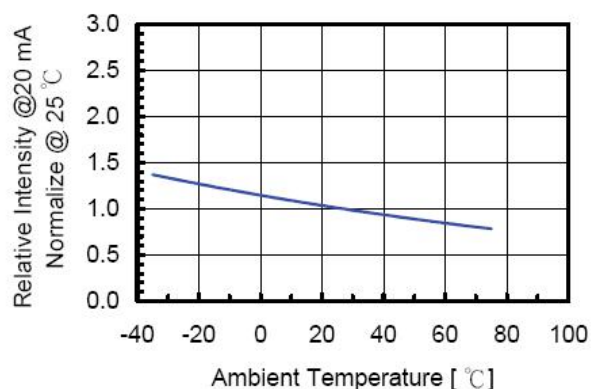
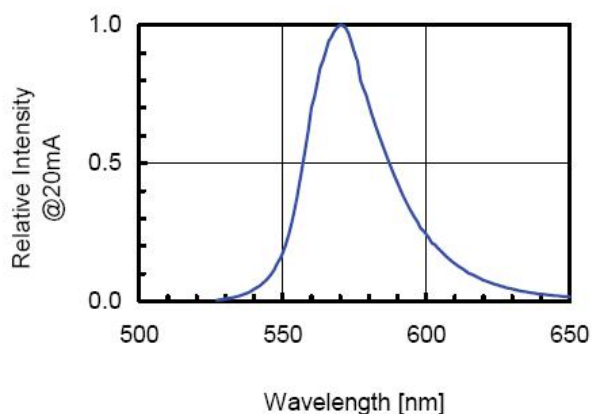


Fig 5. Relative Intensity vs. Wavelength



LED Displays Reliability Test:

CLASSIFICATION	TEST ITEM	DESCRIPTION AND TEST CONDITION
ENDURANCE TEST	OPERATION LIFE	EVALUATES RESISTANCE OF THE DEVICE WHEN OPERATED AT ELECTRICAL STRESS T _a = UNDER ROOM TEMPERATURE I _F = I _F max
	HIGH TEMPERATURE HIGH HUMIDITY STORAGE	EVALUATES MOISTURE RESISTANCE OF THE DEVICE WHEN STORED FOR A LONG TERM AT HIGH TEMPERATURE AND HUMIDITY T _a = 65±5°C RH=90~95%RH TEST TIME=240± 2Hrs
	HIGH TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN HIGH TEMPERATURE T _a = 85±5°C(COB: T _a =65±5°C) TEST TIME=1000Hrs(-24Hrs, +72Hrs)
	LOW TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN LOW TEMPERATURE T _a = -35±5°C TEST TIME=1000Hrs(-24Hrs, +72Hrs)
ENVIRONMENTAL TEST	TEMPERATURE CYCLING	EVALUATES RESISTANCE OF DEVICE AT THERMAL STRESSES OR EXPANSION AND CONTRACTION 85°C ~ 25°C ~ -35°C ~ 25°C 30min 5min 30min 5min 10 CYCLES(COB: Thot=65°C, Tcold=-25°C)
	THERMAL SHOCK	EVALUATES DEVICE STRUCTURE AND STRUCTURE AND MECHANICAL RESISTANCE WHEN SUDDENLY EXPOSED AT SERVE CHANGES 85±5°C ~ -35±5°C 10min 10min 10 CYCLES(COB: Thot=65°C, Tcold=-25°C)
	SOLDERABILITY	EVALUATES SOLDERABILITY ON LEADS OF DEVICE T.SOL=230±5°C DWELL TIME=5±1sec.
	SOLDER RESISTANCE	EVALUATES RESISTANCE TO THERMAL STRESS CAUSED BY SOLDERING T.SOL=260±5°C DWELL TIME=10±1sec.

Packing method A:

175 pcs / Red Expandable Polyethylene.

1050 pcs / Box(360*175*130mm).

6300 pcs / Catton(550*380*280mm).

Packing method B:

40 pcs / IC Tube.

1680 pcs / Box(537*175*125mm).

6720 pcs / Catton(550*380*280mm).